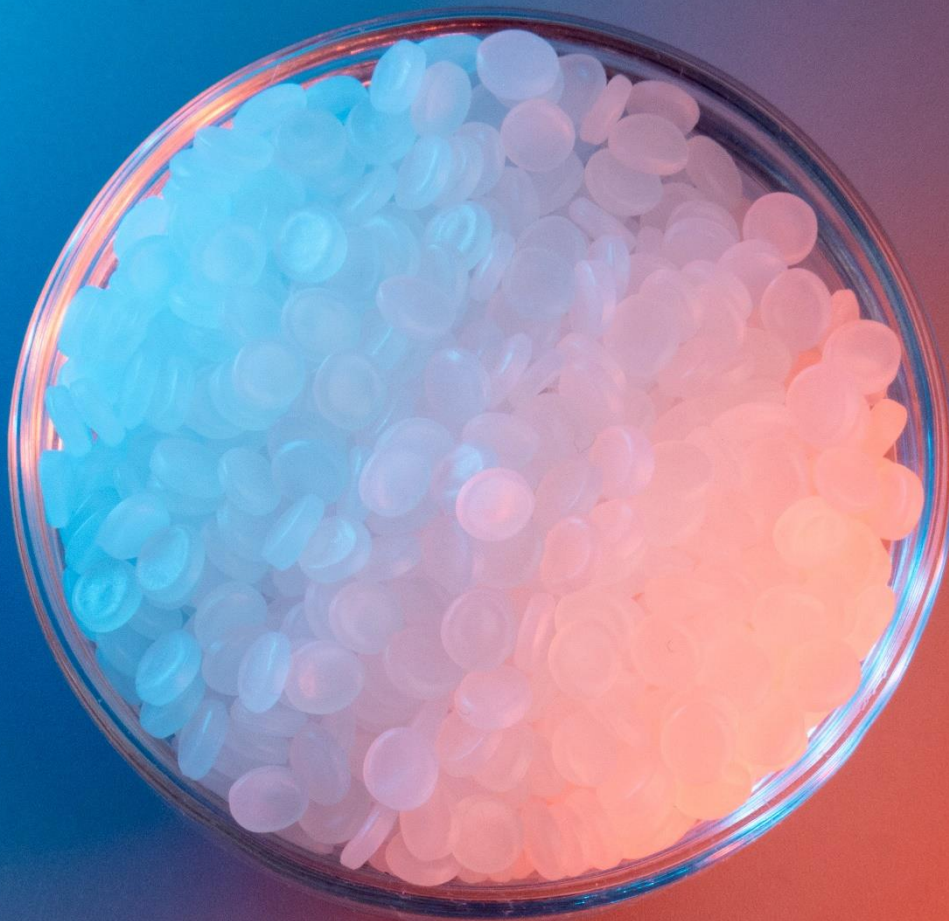


Polyolefins

Data insulation compounds



Data insulation compounds

Description

- ✔ Excellent Oxidative Stability
- ✔ Significant Toughness
- ✔ Uniform Cell Structure
- ✔ Excellent ESCR/TSCR
- ✔ Low Shrinkage / Abrasion
- ✔ Perfect Processability / High Extrusion Speed
- ✔ Good Heat Resistance

Application

- ✔ Coaxial, Foam/Skin and (High speed) LAN Cables
- ✔ Multipair Telephone, CATV and Data Cables
- ✔ Gas Injection Physical and Chemical based High Quality Grades

<i>Class</i>	<i>Grade</i>	<i>Melt index G/10min</i>	<i>Density G/cm³</i>	<i>Application area</i>
<i>Chemical base</i>	CHNA-8380	0.70	0.945	HDPE – Foam, skin & LAN cable
	CHYA-870F	0.80	0.948	HDPE – Cellular – Foam, skin & PEF cable
<i>Physical base</i>	CLNA-8600L	2.00	0.921	LDPE Gas injection
	CLNA-8600H	8.5	0.962	HDPE Gas injection